



MICROWAVE CORPORATION v00.0906



HMC565LC5

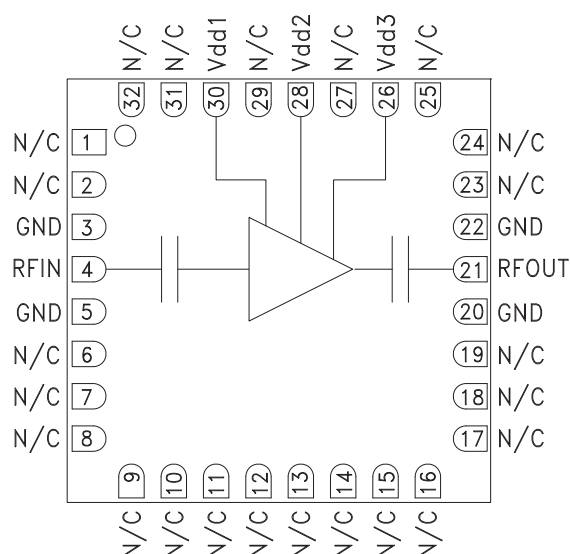
GaAs SMT PHEMT LOW NOISE AMPLIFIER, 6 - 20 GHz

Typical Applications

The HMC565LC5 is ideal for use as a LNA or driver amplifier for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios & VSAT
- Test Equipment and Sensors
- Military & Space

Functional Diagram



Features

Noise Figure: 2.5 dB

Gain: 21 dB

OIP3: 20 dBm

Single Supply: +3V @ 53 mA

50 Ohm Matched Input/Output

RoHS Compliant 5 x 5 mm Package

General Description

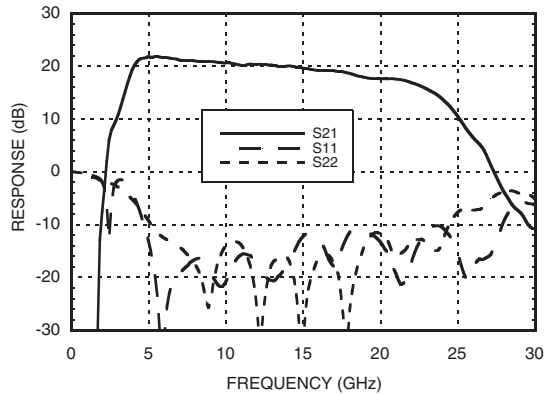
The HMC565LC5 is a high dynamic range GaAs PHEMT MMIC Low Noise Amplifier housed in a leadless RoHS compliant 5x5mm SMT package. Operating from 6 to 20 GHz, the HMC565LC5 features 21 dB of small signal gain, 2.5 dB noise figure and IP3 of +20 dBm across the operating band. This self-biased LNA is ideal for microwave radios due to its single +3V supply operation, and DC blocked RF I/O's.

Electrical Specifications, $T_A = +25^\circ\text{C}$, $V_{dd\ 1, 2, 3} = +3\text{V}$

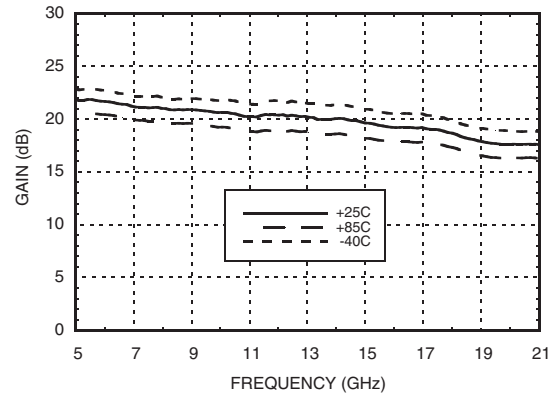
Parameter	Min.	Typ.	Max.	Min.	Typ.	Max.	Units
Frequency Range	6 - 12			12 - 20			GHz
Gain	19	21		16	18.5		dB
Gain Variation Over Temperature		0.025	0.035		0.025	0.035	dB/°C
Noise Figure		2.5	2.8		2.5	3	dB
Input Return Loss		15			12		dB
Output Return Loss		13			15		dB
Output Power for 1 dB Compression (P1dB)	8	10		9	11		dBm
Saturated Output Power (Psat)		11			13		dBm
Output Third Order Intercept (IP3)		20			21		dBm
Total Supply Current (Idd)(Vdd = +3V)		53	75		53	75	mA

GaAs SMT PHEMT LOW NOISE AMPLIFIER, 6 - 20 GHz

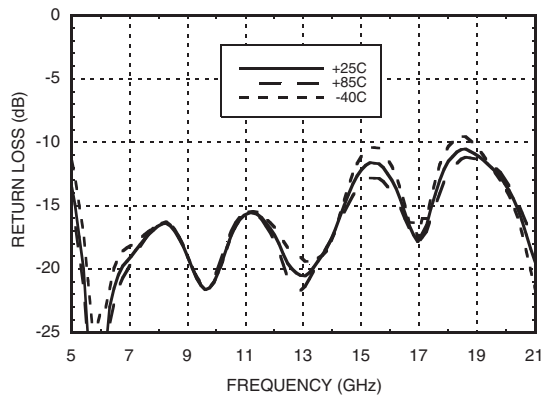
Broadband Gain & Return Loss



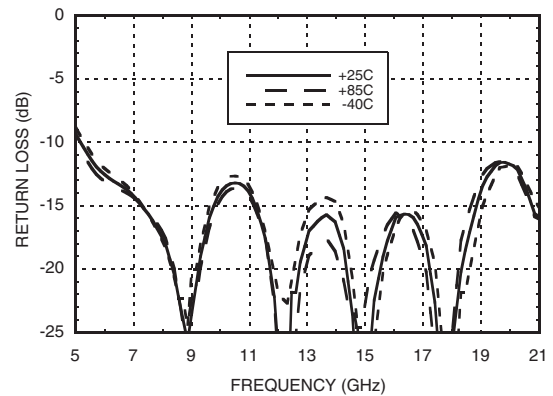
Gain vs. Temperature



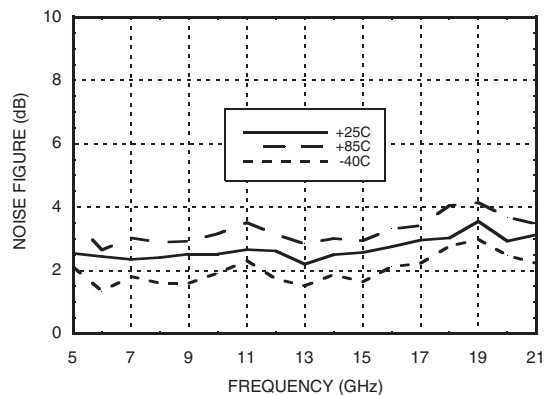
Input Return Loss vs. Temperature



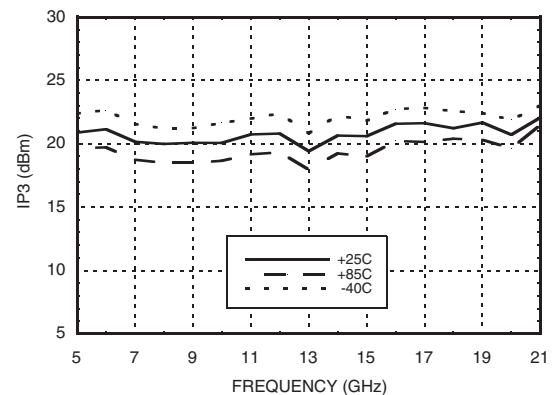
Output Return Loss vs. Temperature



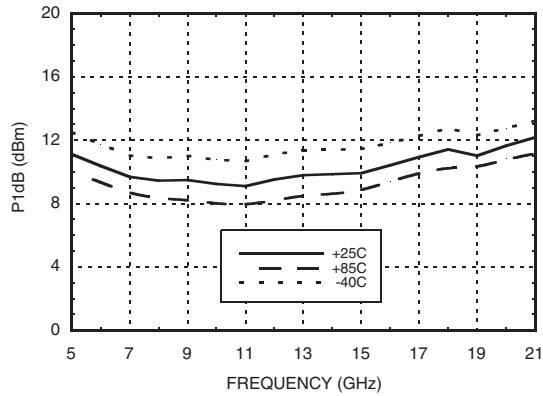
Noise Figure vs. Temperature



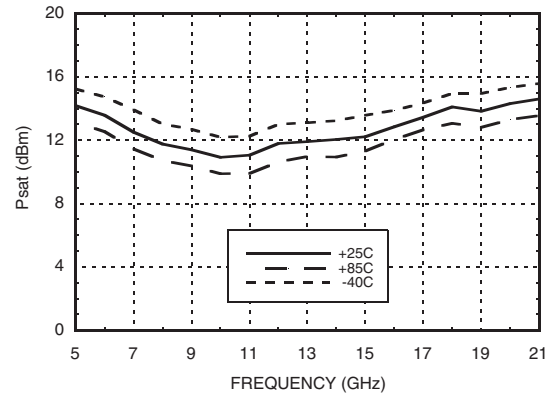
Output IP3 vs. Temperature



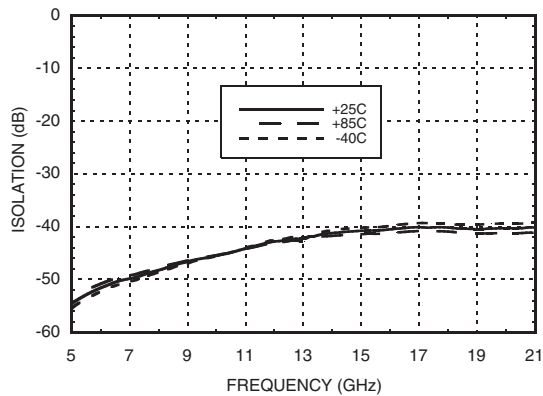
P1dB vs. Temperature



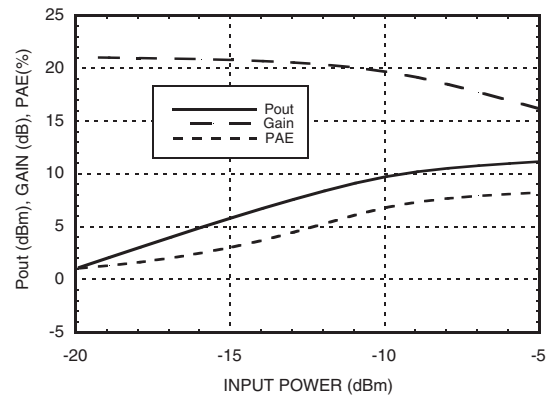
Psat vs. Temperature



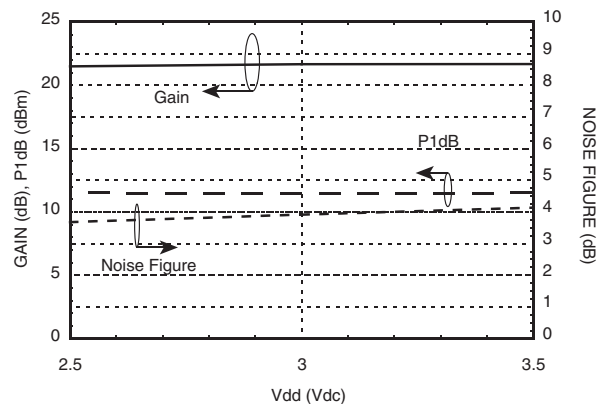
Reverse Isolation vs. Temperature



Power Compression @ 12 GHz



**Gain, Noise Figure & Power vs.
Supply Voltage @ 12 GHz**



Absolute Maximum Ratings

Drain Bias Voltage (Vdd1, Vdd2, Vdd3)	+3.5 Vdc
RF Input Power (RFIN)(Vdd = +3.0 Vdc)	0 dBm
Channel Temperature	175 °C
Continuous Pdiss (T= 85 °C) (derate 8.5 mW/°C above 85 °C)	0.753 W
Thermal Resistance (channel to ground paddle)	119.5 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

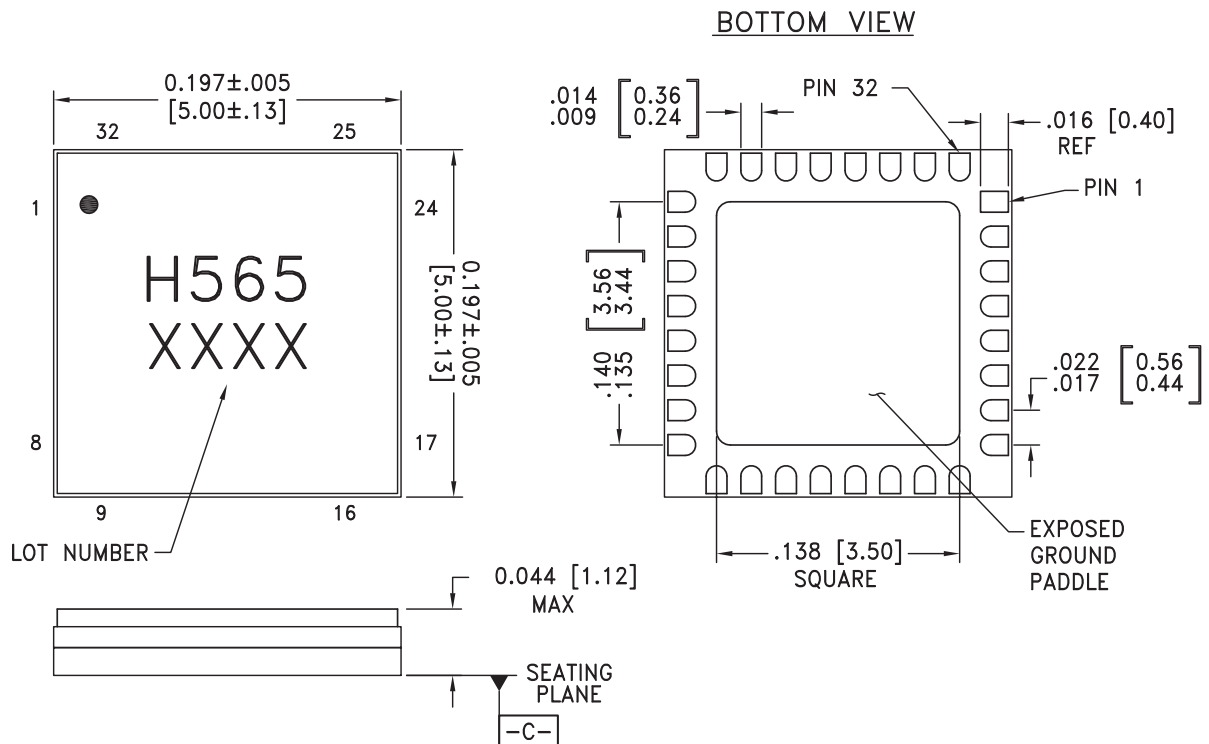
Typical Supply Current vs. Vdd

Vdd (Vdc)	Idd (mA)
+2.5	51
+3.0	53
+3.5	56



ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

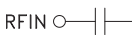
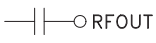
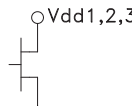
Outline Drawing



NOTES:

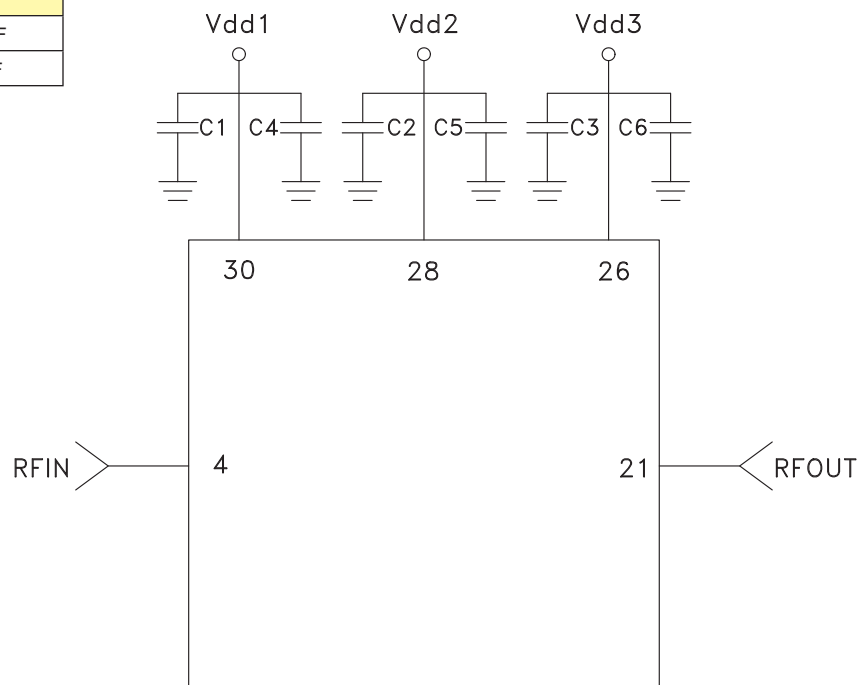
1. PACKAGE BODY MATERIAL: ALUMINA
2. LEAD AND GROUND PADDLE PLATING: 30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL
3. DIMENSIONS ARE IN INCHES [MILLIMETERS]
4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND

Pin Descriptions

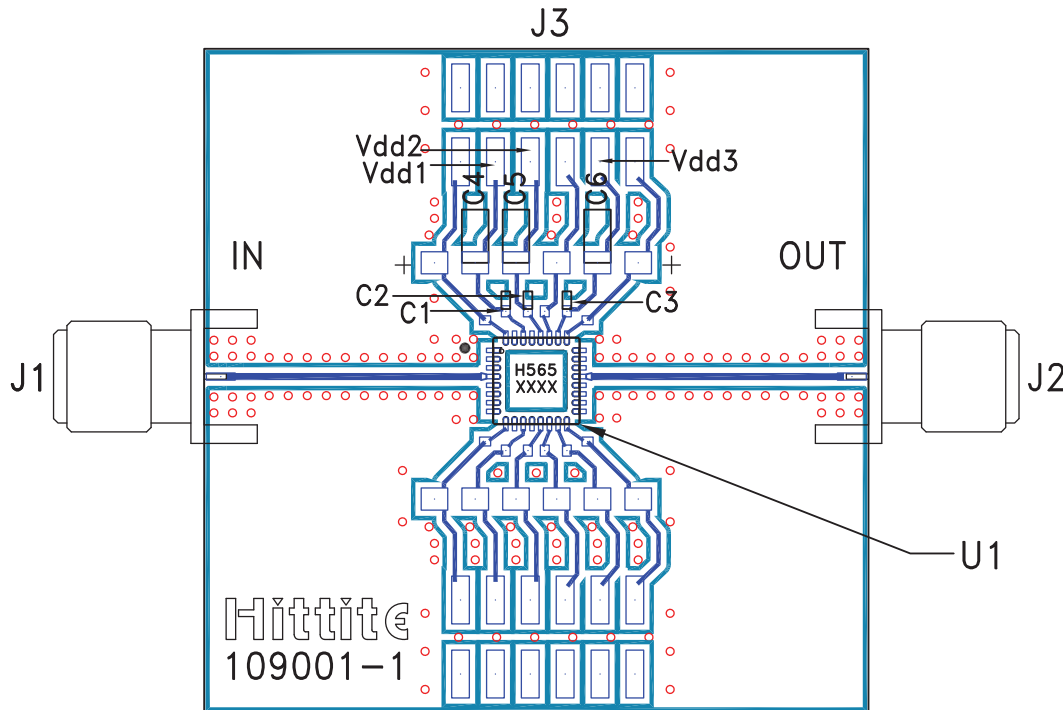
Pin Number	Function	Description	Interface Schematic
1, 2, 6-19, 23-25, 27, 29, 31, 32	N/C	This pin may be connected to RF/DC ground. Performance will not be affected.	
3, 5, 20, 22	GND	These pins and package bottom must be connected to RF/DC ground.	
4	RFIN	This pin is AC coupled and matched to 50 Ohms.	
21	RFOUT	This pin is AC coupled and matched to 50 Ohms.	
30, 28, 26	Vdd1, 2, 3	Power Supply Voltage for the amplifier. External bypass capacitors of 100 pF and 2.2 μF are required.	

Application Circuit

Component	Value
C1, C2, C3	100 pF
C4, C5, C6	2.2 μF



Evaluation PCB



List of Materials for Evaluation PCB 110431 [1]

Item	Description
J1 - J2	PCB Mount K Connector
J3	2 mm DC Header
C1 - C3	100 pF Capacitor, 0402 Pkg.
C4 - C6	2.2 μ F Capacitor, Tantalum
U1	HMC565LC5 Amplifier
PCB [2]	109001 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

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